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In re Application of:
Hideki Kondo
Serial No. To be Assigned
Filing Date: Herewith
For Waveguide for Microwave Device

Commissioner for Patents
Washington, D.C. 20231

Prior to examination of the above-identified application, please amend the application as follows:

Please rewrite Claim 1 as follows:

1. (Amended) A waveguide for a microwave device, comprising:
a frame housing a high-frequency circuit therein; and
a lid attached to a sidewall of the frame,
wherein at least one of the frame and the lid has a waveguide groove
formed therein and extending along a mating surface between the frame and the lid.

Please rewrite Claim 4 as follows:

4. (Amended) The waveguide according to Claim 2, wherein the sub-casing is arranged inside four sidewalls of the main casing and the main casing has a through-hole, through which the probe passes, formed in the sidewall to which the lid is attached.